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Details

-XF

Active
ARM® Cortex®-M4
32-Bit Single-Core
72MHz
CANbus, EBI/EMI, I ² C, IrDA, LINbus, SmartCard, SPI, UART/USART
Brown-out Detect/Reset, DMA, LCD, POR, PWM, WDT
95
2MB (2M × 8)
FLASH
-
384K x 8
1.8V ~ 3.8V
A/D 16x12b SAR; D/A 2x12b
Internal
-40°C ~ 85°C (TA)
Surface Mount
120-VFBGA
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https://www.e-xfl.com/product-detail/silicon-labs/efm32gg11b510f2048gl120-b

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4.1.7 Current Consumption

4.1.7.1 Current Consumption 3.3 V without DC-DC Converter

Unless otherwise indicated, typical conditions are: VREGVDD = AVDD = DVDD = 3.3 V. T = 25 °C. DCDC is off. Minimum and maximum values in this table represent the worst conditions across supply voltage and process variation at T = 25 °C.

Table 4.7. Current Consumption 3.3 V without DC-DC Converter

Parameter	Symbol	Test Condition	Min	Тур	Мах	Unit
Current consumption in EM0 mode with all peripherals dis-	IACTIVE	72 MHz HFRCO, CPU running Prime from flash	—	120	—	µA/MHz
abled		72 MHz HFRCO, CPU running while loop from flash	—	120	TBD	µA/MHz
		72 MHz HFRCO, CPU running CoreMark loop from flash	—	140		µA/MHz
		50 MHz crystal, CPU running while loop from flash	—	123	—	µA/MHz
		48 MHz HFRCO, CPU running while loop from flash	_	122	TBD	µA/MHz
		32 MHz HFRCO, CPU running while loop from flash	_	124	—	µA/MHz
		26 MHz HFRCO, CPU running while loop from flash	—	126	TBD	µA/MHz
		16 MHz HFRCO, CPU running while loop from flash	—	131	—	µA/MHz
		1 MHz HFRCO, CPU running while loop from flash	—	319	TBD	µA/MHz
Current consumption in EM0 mode with all peripherals dis-	IACTIVE_VS	19 MHz HFRCO, CPU running while loop from flash	_	107	—	µA/MHz
enabled		1 MHz HFRCO, CPU running while loop from flash	—	262	—	µA/MHz
Current consumption in EM1	I _{EM1}	72 MHz HFRCO	—	57	TBD	µA/MHz
abled		50 MHz crystal	—	60	—	µA/MHz
		48 MHz HFRCO	—	59	TBD	µA/MHz
		32 MHz HFRCO	—	61	_	µA/MHz
		26 MHz HFRCO	—	63	TBD	µA/MHz
		16 MHz HFRCO		68		µA/MHz
		1 MHz HFRCO	_	255	TBD	µA/MHz
Current consumption in EM1	I _{EM1_VS}	19 MHz HFRCO	—	55	—	µA/MHz
mode with all peripherals dis- abled and voltage scaling enabled	_	1 MHz HFRCO	—	210	_	µA/MHz

Parameter	Symbol	Test Condition	Min	Тур	Мах	Unit
Current consumption in EM2 mode, with voltage scaling	I _{EM2_VS}	Full 512 kB RAM retention and RTCC running from LFXO	—	3.9		μA
enabled		Full 512 kB RAM retention and RTCC running from LFRCO	—	4.3	_	μA
		16 kB (1 bank) RAM retention and RTCC running from LFRCO ²	—	2.8	TBD	μA
Current consumption in EM3 mode, with voltage scaling enabled	I _{EM3_VS}	Full 512 kB RAM retention and CRYOTIMER running from ULFR- CO	_	3.6	TBD	μA
Current consumption in EM4H mode, with voltage	I _{EM4H_VS}	128 byte RAM retention, RTCC running from LFXO	—	1.08	_	μA
scaling enabled		128 byte RAM retention, CRYO- TIMER running from ULFRCO	—	0.69	_	μA
		128 byte RAM retention, no RTCC	—	0.69	TBD	μA
Current consumption in EM4S mode	I _{EM4S}	No RAM retention, no RTCC	—	0.16	TBD	μA
Current consumption of pe- ripheral power domain 1, with voltage scaling enabled	IPD1_VS	Additional current consumption in EM2/3 when any peripherals on power domain 1 are enabled ¹	_	0.68	_	μA
Current consumption of pe- ripheral power domain 2, with voltage scaling enabled	I _{PD2_VS}	Additional current consumption in EM2/3 when any peripherals on power domain 2 are enabled ¹	_	0.28	_	μA

1. Extra current consumed by power domain. Does not include current associated with the enabled peripherals. See 3.2.4 EM2 and EM3 Power Domains for a list of the peripherals in each power domain.

2. CMU_LFRCOCTRL_ENVREF = 1, CMU_LFRCOCTRL_VREFUPDATE = 1

Parameter	Symbol	Test Condition	Min	Тур	Мах	Unit
Frequency limits	f _{HFRCO_BAND}	FREQRANGE = 0, FINETUNIN- GEN = 0	1	_	10	MHz
		FREQRANGE = 3, FINETUNIN- GEN = 0	2	—	17	MHz
		FREQRANGE = 6, FINETUNIN- GEN = 0	4	—	30	MHz
		FREQRANGE = 7, FINETUNIN- GEN = 0	5	—	34	MHz
		FREQRANGE = 8, FINETUNIN- GEN = 0	7	_	42	MHz
		FREQRANGE = 10, FINETUNIN- GEN = 0	12	_	58	MHz
		FREQRANGE = 11, FINETUNIN- GEN = 0	15		68	MHz
		FREQRANGE = 12, FINETUNIN- GEN = 0	18	_	83	MHz
		FREQRANGE = 13, FINETUNIN- GEN = 0	24		100	MHz
		FREQRANGE = 14, FINETUNIN- GEN = 0	28	_	119	MHz
		FREQRANGE = 15, FINETUNIN- GEN = 0	33	_	138	MHz
		FREQRANGE = 16, FINETUNIN- GEN = 0	43		163	MHz

1. Maximum DPLL lock time ~= 6 x (M+1) x t_{REF} , where t_{REF} is the reference clock period.

Parameter	Symbol	Test Condition	Min	Тур	Мах	Unit
Slew rate ⁵	SR	DRIVESTRENGTH = 3, INCBW=1 ³		4.7	—	V/µs
		DRIVESTRENGTH = 3, INCBW=0	—	1.5	_	V/µs
		DRIVESTRENGTH = 2, INCBW=1 ³		1.27	_	V/µs
		DRIVESTRENGTH = 2, INCBW=0		0.42		V/µs
		DRIVESTRENGTH = 1, INCBW=1 ³		0.17	_	V/µs
		DRIVESTRENGTH = 1, INCBW=0		0.058	_	V/µs
		DRIVESTRENGTH = 0, INCBW=1 ³		0.044	_	V/µs
		DRIVESTRENGTH = 0, INCBW=0	_	0.015	_	V/µs
Startup time ⁶	T _{START}	DRIVESTRENGTH = 2	—	—	12	μs
Input offset voltage	V _{OSI}	DRIVESTRENGTH = 2 or 3, T = 25 °C	TBD	_	TBD	mV
		DRIVESTRENGTH = 1 or 0, T = 25 °C	TBD	—	TBD	mV
		DRIVESTRENGTH = 2 or 3, across operating temperature range	TBD	_	TBD	mV
		DRIVESTRENGTH = 1 or 0, across operating temperature range	TBD	_	TBD	mV
DC power supply rejection ratio ⁹	PSRR _{DC}	Input referred		70	_	dB
DC common-mode rejection ratio ⁹	CMRR _{DC}	Input referred		70	_	dB
Total harmonic distortion	THD _{OPA}	DRIVESTRENGTH = 2, 3x Gain connection, 1 kHz, V_{OUT} = 0.1 V to V_{OPA} - 0.1 V		90		dB
		DRIVESTRENGTH = 0, 3x Gain connection, 0.1 kHz, V_{OUT} = 0.1 V to V_{OPA} - 0.1 V	_	90		dB



Figure 4.13. SDIO DS Mode Timing

SDIO MMC SDR Mode Timing at 1.8 V

Timing is specified for route location 0 at 1.8 V IOVDD with voltage scaling disabled. Slew rate for SD_CLK set to 7, all other GPIO set to 6, DRIVESTRENGTH = STRONG for all pins. SDIO_CTRL_TXDLYMUXSEL = 1. Loading between 5 and 10 pF on all pins or between 10 and 20 pF on all pins.

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Clock frequency during data transfer	F _{SD_CLK}	Using HFRCO, AUXHFRCO, or USHFRCO	_	_	25	MHz
		Using HFXO	_		TBD	MHz
Clock low time	t _{WL}	Using HFRCO, AUXHFRCO, or USHFRCO	18.1	—	—	ns
		Using HFXO	TBD	—	—	ns
Clock high time	t _{WH}	Using HFRCO, AUXHFRCO, or USHFRCO	18.1	_	—	ns
		Using HFXO	TBD	_	—	ns
Clock rise time	t _R		1.96	8.27	—	ns
Clock fall time	t _F		1.67	6.90	_	ns
Input setup time, CMD, DAT[0:7] valid to SD_CLK	t _{ISU}		5.3		_	ns
Input hold time, SD_CLK to CMD, DAT[0:7] change	t _{IH}		2.5		_	ns
Output delay time, SD_CLK to CMD, DAT[0:7] valid	todly		0	—	16	ns
Output hold time, SD_CLK to CMD, DAT[0:7] change	t _{OH}		3	_	_	ns

Table 4.50. SDIO MMC SDR Mode Timing (Location 0, 1.8V I/O)

QSPI SDR Mode Timing (Locations 1, 2)

Timing is specified with voltage scaling disabled, PHY-mode, route locations other than 0, TX DLL = 34, RX DLL = 59, 20-25 pF loading per GPIO, and slew rate for all GPIO set to 6, DRIVESTRENGTH = STRONG.

Table 4.55. QSPI SDR Mode Timing (Locations 1, 2)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Full SCLK period	Т		(1/F _{SCLK}) * 0.95	—	_	ns
Output valid	t _{OV}		—	_	T/2 - 2.1	ns
Output hold	t _{OH}		T/2 - 42.3	—	_	ns
Input setup	t _{SU}		48.2 - T/2	_	_	ns
Input hold	t _H		T/2 - 5.1	_		ns



DQx Input Timing



Figure 4.21. QSPI SDR Timing Diagrams

QSPI SDR Flash Timing Example

This example uses timing values for location 0 (SDR mode) to demonstrate the calculation of allowable flash timing using the QSPI in SDR mode.

- Using a configured SCLK frequency (F_{SCLK}) of 19 MHz:
- The resulting minimum period, T(min) = (1/F_{SCLK}) * 0.95 = 50.0 ns.
- Flash will see a minimum setup time of T/2 t_{OV} = T/2 (T/2 2.4) = 2.4 ns.
- Flash will see a minimum hold time of $T/2 + t_{OH} = T/2 + (T/2 32.9) = T 32.9 = 50.0 32.9 = 17.1 ns.$
- Flash can have a maximum output valid time of T/2 t_{SU} = T/2 (36.2 T/2) = T 36.2 = 50.0 36.2 = 13.8 ns.
- Flash can have a minimum output hold time of $t_H T/2 = (T/2 3.3) T/2 = -3.3$ ns.

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PA15	B1	GPIO	PE14	B2	GPIO
PE12	B3	GPIO	PE8	B4	GPIO
PD11	B5	GPIO	PD9	B6	GPIO
PF8	B7	GPIO	PF6	B8	GPIO
PF14	B9	GPIO (5V)	PF12	B10	GPIO
PF2	B11	GPIO	PF0	B12	GPIO (5V)
PC14	B13	GPIO (5V)	VREGO	B14	Decoupling for 5 V regulator and regu- lator output. Power for USB PHY in USB-enabled OPNs
PA1	C1	GPIO	PA0	C2	GPIO
PD13	C3	GPIO (5V)	PE10	C4	GPIO
PI8	C5	GPIO (5V)	PI7	C6	GPIO (5V)
Pl6	C7	GPIO (5V)	PF5	C8	GPIO
PF15	C9	GPIO (5V)	PF4	C10	GPIO
PF3	C11	GPIO	PC13	C12	GPIO (5V)
PC12	C13	GPIO (5V)	VREGI	C14	Input to 5 V regulator.
PA3	D1	GPIO	PA2	D2	GPIO
PD14	D3	GPIO (5V)	PC11	D12	GPIO (5V)
PC10	D13	GPIO (5V)	PC9	D14	GPIO (5V)
PA5	E1	GPIO	PA4	E2	GPIO
PD15	E3	GPIO (5V)	IOVDD1	E6	Digital IO power supply 1.
VSS	E7 E8 G5 G7 G8 G10 H5 H7 H8 H10 K7 K8	Ground	IOVDD0	E9 F10 J5 J10 K6 K9	Digital IO power supply 0.
PC8	E12	GPIO (5V)	PI5	E13	GPIO (5V)
Pl4	E14	GPIO (5V)	PG0	F1	GPIO (5V)
PA6	F2	GPIO	PG1	F3	GPIO (5V)
IOVDD2	F5	Digital IO power supply 2.	PI3	F12	GPIO (5V)
PI2	F13	GPIO (5V)	PI1	F14	GPIO (5V)
PG3	G1	GPIO (5V)	PG4	G2	GPIO (5V)
PG2	G3	GPIO (5V)	PE7	G12	GPIO
P10	G13	GPIO (5V)	DECOUPLE	G14	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.



Figure 5.3. EFM32GG11B8xx in BGA120 Device Pinout

The following table provides package pin connections and general descriptions of pin functionality. For detailed information on the supported features for each GPIO pin, see 5.20 GPIO Functionality Table or 5.21 Alternate Functionality Overview.

Table 5.3. EFM32GG11B8xx in BGA120 Device Pinor

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PE15	A1	GPIO	PE14	A2	GPIO
PE12	A3	GPIO	PE9	A4	GPIO
PD11	A5	GPIO	PD9	A6	GPIO
PF7	A7	GPIO	PF5	A8	GPIO
PF14	A9	GPIO (5V)	PF12	A10	GPIO
VREGI	A11	Input to 5 V regulator.	VREGO	A12	Decoupling for 5 V regulator and regu- lator output. Power for USB PHY in USB-enabled OPNs

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PC1	K2	GPIO (5V)	PE0	K12	GPIO (5V)
VREGSW	K13	DCDC regulator switching node	PC2	L1	GPIO (5V)
PC3	L2	GPIO (5V)	PA7	L3	GPIO
PB9	L13	GPIO (5V)	PB10	L14	GPIO (5V)
PD1	L17	GPIO	PC6	L18	GPIO
PC7	L19	GPIO	VREGVSS	L20	Voltage regulator VSS
PB7	M1	GPIO	PC4	M2	GPIO
PA8	M3	GPIO	PA10	M4	GPIO
PA13	M5	GPIO (5V)	PA14	M6	GPIO
RESETn	M7	Reset input, active low. To apply an ex- ternal reset source to this pin, it is re- quired to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.	PB12	M8	GPIO
PD0	M9	GPIO (5V)	PD2	M10	GPIO (5V)
PD3	M11	GPIO	PD4	M12	GPIO
PD8	M13	GPIO	PB8	N1	GPIO
PC5	N2	GPIO	PA9	N3	GPIO
PA11	N4	GPIO	PA12	N5	GPIO (5V)
PB11	N6	GPIO	BODEN	N7	Brown-Out Detector Enable. This pin may be left disconnected or tied to AVDD.
PB13	N8	GPIO	PB14	N9	GPIO
AVDD	N10	Analog power supply.	PD5	N11	GPIO
PD6	N12	GPIO	PD7	N13	GPIO

1. GPIO with 5V tolerance are indicated by (5V).

2. The pins PD13, PD14, and PD15 will not be 5V tolerant on all future devices. In order to preserve upgrade options with full hardware compatibility, do not use these pins with 5V domains.

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PD15	J2	GPIO (5V)	PC6	J12	GPIO
DECOUPLE	J13	Decouple output for on-chip voltage regulator. An external decoupling ca- pacitor is required at this pin.	PC0	K1	GPIO (5V)
PC1	K2	GPIO (5V)	PD8	K13	GPIO
PC2	L1	GPIO (5V)	PC3	L2	GPIO (5V)
PA7	L3	GPIO	PB9	L15	GPIO (5V)
PB10	L16	GPIO (5V)	PD0	L17	GPIO (5V)
PD1	L18	GPIO	PD4	L19	GPIO
PD7	L20	GPIO	PB7	M1	GPIO
PC4	M2	GPIO	PA8	M3	GPIO
PA10	M4	GPIO	PA13	M5	GPIO (5V)
PA14	M6	GPIO	RESETn	M7	Reset input, active low. To apply an ex- ternal reset source to this pin, it is re- quired to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.
AVDD	M9 M10 N11	Analog power supply.	PD3	M12	GPIO
PD6	M13	GPIO	PB8	N1	GPIO
PC5	N2	GPIO	PA9	N3	GPIO
PA11	N4	GPIO	PA12	N5	GPIO (5V)
PB11	N6	GPIO	PB12	N7	GPIO
PB13	N9	GPIO	PB14	N10	GPIO
PD2	N12	GPIO (5V)	PD5	N13	GPIO

1. GPIO with 5V tolerance are indicated by (5V).

2. The pins PD13, PD14, and PD15 will not be 5V tolerant on all future devices. In order to preserve upgrade options with full hardware compatibility, do not use these pins with 5V domains.

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description	
PB2	11	GPIO	PB3	12	GPIO	
PB4	13	GPIO	PB5	14	GPIO	
PB6	15	GPIO	VSS	16 32 58 83	Ground	
PC0	18	GPIO (5V)	PC1	19	GPIO (5V)	
PC2	20	GPIO (5V)	PC3	21	GPIO (5V)	
PC4	22	GPIO	PC5	23	GPIO	
PB7	24	GPIO	PB8	25	GPIO	
PA7	26	GPIO	PA8	27	GPIO	
PA9	28	GPIO	PA10	29	GPIO	
PA11	30	GPIO	PA12	33	GPIO (5V)	
PA13	34	GPIO (5V)	PA14	35	GPIO	
RESETn	36	Reset input, active low. To apply an ex- ternal reset source to this pin, it is re- quired to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.	PB9	37	GPIO (5V)	
PB10	38	GPIO (5V)	PB11	39	GPIO	
PB12	40	GPIO	AVDD	41 45	Analog power supply.	
PB13	42	GPIO	PB14	43	GPIO	
PD0	46	GPIO (5V)	PD1	47	GPIO	
PD2	48	GPIO (5V)	PD3	49	GPIO	
PD4	50	GPIO	PD5	51	GPIO	
PD6	52	GPIO	PD7	53	GPIO	
PD8	54	GPIO	PC6	55	GPIO	
PC7	56	GPIO	DVDD	57	Digital power supply.	
DECOUPLE	59	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.	PE0	60	GPIO (5V)	
PE1	61	GPIO (5V)	PE2	62	GPIO	
PE3	63	GPIO	PE4	64	GPIO	
PE5	65	GPIO	PE6	66	GPIO	
PE7	67	GPIO	PC8	68	GPIO (5V)	
PC9	69	GPIO (5V)	PC10	70	GPIO (5V)	
PC11	71	GPIO (5V)	VREGI	72	Input to 5 V regulator.	
VREGO	73	Decoupling for 5 V regulator and regu- lator output. Power for USB PHY in USB-enabled OPNs	PF10	74	GPIO (5V)	
PF11	75	GPIO (5V)	PF0	76	GPIO (5V)	

GPIO Name	Pin Alternate Functionality / Description						
	Analog	EBI Timers Communication		Other			
PF14	BUSDY BUSCX		TIM1_CC1 #6 TIM4_CC1 #1 TIM5_CC2 #7 WTIM3_CC1 #7	I2C2_SCL #4			
PF11	BUSCY BUSDX	EBI_NANDWEn #5	TIM5_CC2 #6 WTIM3_CC2 #3 PCNT2_S1IN #3	US5_CTS #2 U1_RX #1 I2C2_SCL #2 USB_DP			
PF10	BUSDY BUSCX	EBI_ARDY #5	TIM5_CC1 #6 WTIM3_CC1 #3 PCNT2_S0IN #3	US5_RTS #2 U1_TX #1 I2C2_SDA #2 USB_DM			
PF0	BUSDY BUSCX	EBI_A24 #1	TIM0_CC0 #4 WTIM0_CC1 #4 LE- TIM0_OUT0 #2	US2_TX #5 CAN0_RX #1 US1_CLK #2 LEU0_TX #3 I2C0_SDA #5	PRS_CH15 #2 ACMP3_O #0 DBG_SWCLKTCK BOOT_TX		
PA0	BUSBY BUSAX LCD_SEG13	EBI_AD09 #0 EBI_CSTFT #3	TIM0_CC0 #0 TIM0_CC1 #7 TIM3_CC0 #4 PCNT0_S0IN #4	ETH_RMIITXEN #0 ETH_MIITXCLK #0 SDIO_DAT0 #1 US1_RX #5 US3_TX #0 QSPI0_CS0 #1 LEU0_RX #4 I2C0_SDA #0	CMU_CLK2 #0 PRS_CH0 #0 PRS_CH3 #3 GPIO_EM4WU0		
PD11	LCD_SEG30	EBI_CS2 #0 EBI_HSNC #1	TIM4_CC0 #6 WTIM3_CC2 #0	ETH_RMIICRSDV #1 SDIO_DAT5 #0 QSPI0_DQ2 #0 ETH_MIIRXD3 #2 US4_CLK #1			
PD10	LCD_SEG29	EBI_CS1 #0 EBI_VSNC #1	TIM4_CC2 #5 WTIM3_CC1 #0	ETH_RMIIREFCLK #1 SDIO_DAT6 #0 QSPI0_DQ1 #0 ETH_MIIRXD2 #2 US4_RX #1	CMU_CLK2 #5 CMU_CLKI0 #5		
PD9	LCD_SEG28	EBI_CS0 #0 EBI_DTEN #1	TIM4_CC1 #5 WTIM3_CC0 #0	ETH_RMIIRXD0 #1 SDIO_DAT7 #0 QSPI0_DQ0 #0 ETH_MIIRXD1 #2 US4_TX #1			
PF9	BUSCY BUSDX LCD_SEG27	EBI_REn #4 EBI_BL1 #1	TIM4_CC0 #5	ETH_RMIIRXD1 #1 US2_CS #4 QSPI0_DQS #0 ETH_MIIRXD0 #2 ETH_TSUTMRTOG #3 SDI0_WP #0 U0_RTS #0 U1_CTS #1	ETM_TD0 #1		
PF8	BUSDY BUSCX LCD_SEG26	EBI_WEn #4 EBI_BL0 #1	TIM0_CC2 #1 TIM4_CC2 #4	ETH_RMIITXEN #1 US2_CLK #4 QSPI0_CS1 #0 ETH_MIIRXDV #2 ETH_TSUEXTCLK #3 SDIO_CD #0 U0_CTS #0 U1_RTS #1	ETM_TCLK #1 GPIO_EM4WU8		

GPIO Name	Pin Alternate Functionality / Description						
	Analog	EBI	Timers	Communication	Other		
PB13	BUSAY BUSBX HFXTAL_P		TIM6_CC0 #5 WTIM1_CC0 #0 PCNT2_S0IN #2	US0_CLK #4 US1_CTS #5 US5_CS #0 LEU0_TX #1	CMU_CLKI0 #3 PRS_CH7 #0		
PB14	BUSBY BUSAX HFXTAL_N		TIM6_CC1 #5 WTIM1_CC1 #0 PCNT2_S1IN #2	US0_CS #4 US1_RTS #5 US5_CTS #0 LEU0_RX #1	PRS_CH6 #1		
PD1	VDAC0_OUT1ALT / OPA1_OUTALT #4 BUSADC0Y BU- SADC0X OPA3_OUT	EBI_A05 #1 EBI_A14 #3	TIM4_CDTI1 TIM0_CC0 #2 TIM6_CC0 #6 WTIM1_CC3 #0 PCNT2_S1IN #0	CAN0_TX #2 US1_RX #1	DBG_SWO #2		
PD6	BUSADCOY BU- SADCOX ADC0_EXTP VDAC0_EXT ADC1_EXTP OPA1_P	EBI_A10 #1 EBI_A19 #3	TIM1_CC0 #4 TIM6_CC2 #7 WTIM0_CDTI2 #4 WTIM1_CC0 #2 LE- TIM0_OUT0 #0 PCNT0_S0IN #3	US0_RTS #5 US1_RX #2 US2_CTS #5 US3_CTS #2 U0_RTS #5 I2C0_SDA #1	CMU_CLK2 #2 LES_ALTEX0 PRS_CH5 #2 ACMP0_O #2 ETM_TD0 #0		

5.21 Alternate Functionality Overview

A wide selection of alternate functionality is available for multiplexing to various pins. The following table shows the name of the alternate functionality in the first column, followed by columns showing the possible LOCATION bitfield settings and the associated GPIO pin. Refer to 5.20 GPIO Functionality Table for a list of functions available on each GPIO pin.

Note: Some functionality, such as analog interfaces, do not have alternate settings or a LOCATION bitfield. In these cases, the pinout is shown in the column corresponding to LOCATION 0.

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
ACMP0_O	0: PE13 1: PE2 2: PD6 3: PB11	4: PA6 5: PB0 6: PB2 7: PB3	Analog comparator ACMP0, digital output.
ACMP1_O	0: PF2 1: PE3 2: PD7 3: PA12	4: PA14 5: PB9 6: PB10 7: PA5	Analog comparator ACMP1, digital output.
ACMP2_O	0: PD8 1: PE0 2: PE1 3: PI0	4: Pl1 5: Pl2	Analog comparator ACMP2, digital output.
ACMP3_O	0: PF0 1: PC15 2: PC14 3: PC13	4: Pl4 5: Pl5	Analog comparator ACMP3, digital output.
ADC0_EXTN	0: PD7		Analog to digital converter ADC0 external reference input negative pin.
ADC0_EXTP	0: PD6		Analog to digital converter ADC0 external reference input positive pin.
ADC1_EXTN	0: PD7		Analog to digital converter ADC1 external reference input negative pin.
ADC1_EXTP	0: PD6		Analog to digital converter ADC1 external reference input positive pin.
BOOT_RX	0: PF1		Bootloader RX.
BOOT_TX	0: PF0		Bootloader TX.

Table 5.21. Alternate Functionality Overview

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
US5 RX	0: PE9 1: PA7		USART5 Asynchronous Receive.
	2: PB1 3: PH11		USART5 Synchronous mode Master Input / Slave Output (MISO).
US5_TX	0: PE8 1: PA6		USART5 Asynchronous Transmit. Also used as receive input in half duplex communica- tion.
	2. PF 15 3: PH10		USART5 Synchronous mode Master Output / Slave Input (MOSI).
USB_DM	0: PF10		USB D- pin.
USB_DP	0: PF11		USB D+ pin.
USB_ID	0: PF12		USB ID pin.
USB_VBUSEN	0: PF5		USB 5 V VBUS enable.
VDAC0_EXT	0: PD6		Digital to analog converter VDAC0 external reference input pin.
VDAC0_OUT0 / OPA0_OUT	0: PB11		Digital to Analog Converter DAC0 output channel number 0.
VDAC0_OUT0ALT / OPA0_OUTALT	0: PC0 1: PC1 2: PC2 3: PC3	4: PD0	Digital to Analog Converter DAC0 alternative output for channel 0.
VDAC0_OUT1 / OPA1_OUT	0: PB12		Digital to Analog Converter DAC0 output channel number 1.
VDAC0_OUT1ALT / OPA1_OUTALT	0: PC12 1: PC13 2: PC14 3: PC15	4: PD1	Digital to Analog Converter DAC0 alternative output for channel 1.
WTIM0_CC0	0: PE4 1: PA6 2: PG2 3: PG8	4: PC15 5: PB0 6: PB3 7: PC1	Wide timer 0 Capture Compare input / output channel 0.
WTIM0_CC1	0: PE5 1: PD13 2: PG3 3: PG9	4: PF0 5: PB1 6: PB4 7: PC2	Wide timer 0 Capture Compare input / output channel 1.

Table 6.2. BGA192 PCB Land Pattern Dimensions

Dimension	Min	Nom	Мах		
Х	0.20				
C1	6.00				
C2	6.00				
E1		0.4			
E2	0.4				

Note:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.

2. Dimensioning and Tolerancing is per the ANSI Y14.5M-1994 specification.

3. This Land Pattern Design is based on the IPC-7351 guidelines.

4. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 μm minimum, all the way around the pad.

5. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.

6. The stencil thickness should be 0.125 mm (5 mils).

7. The ratio of stencil aperture to land pad size should be 1:1.

8. A No-Clean, Type-3 solder paste is recommended.

9. The recommended card reflow profile is per the JEDEC/IPC J-STD-020C specification for Small Body Components.

7. BGA152 Package Specifications

7.1 BGA152 Package Dimensions



Figure 7.1. BGA152 Package Drawing

10. TQFP100 Package Specifications

10.1 TQFP100 Package Dimensions





10.2 TQFP100 PCB Land Pattern



Figure 10.2. TQFP100 PCB Land Pattern Drawing